

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re U.S. Patent Application of**

**TACHIBANA et. al.**

**Application Number: To be Assigned**

**Filed: Concurrently Herewith**

**For: HEAT SPREADER AND SEMICONDUCTOR  
DEVICE AND PACKAGE USING THE SAME**

**Attorney Docket No. KOBE.0057**

**Honorable Assistant Commissioner  
for Patents  
Washington, D.C. 20231**

**PRELIMINARY AMENDMENT**

Sir:

Prior to an examination on the merits, please amend the above-identified application as follows: